

NOTES:

MATERIAL:

1. HOUSING MATERIAL :GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL :PHOSPHOR BRONZE t=0.30mm.
3. PLATING :SELECTING GOLD PLATING 1u"~50u"OVER NICKEL IN CONTACT AREA. 150u" TIN PLATING OVER NICKEL IN SOLDER AREA

4. SHIELD: :0.20mmTHICKNESS COPPER ALLY WITH NICKEL PLATE
- ELECTRICAL:

1. VOLTAGE RATING :125 VAC RMS.
2. CURRENT RATING :1.5 AMP.
3. CONTACT RESISTANCE :30 MILLIOHMS MAX.
4. INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC .
5. DIELECTRIC WITHSTANDING RESISTANCE

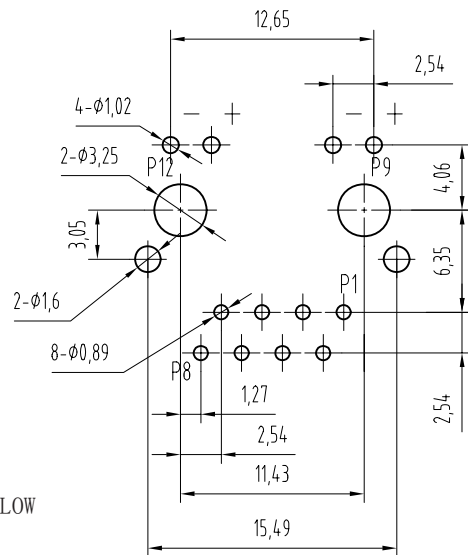
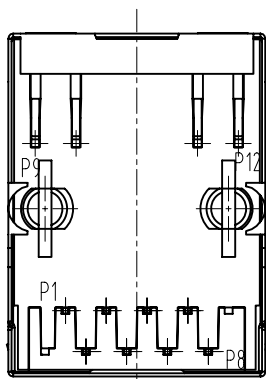
:1000V AC RMS 50Hz. 1MIN.

MECHANICAL:

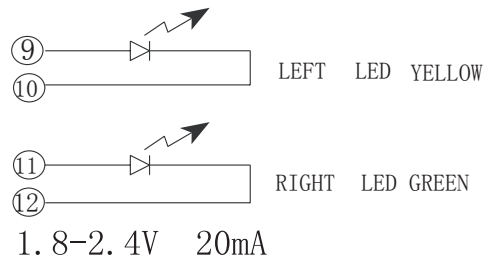
1. DURRABILITY: :750 CYCLES MIN.
2. PCB RETENTION PRE-SOLDER :1 LB MIN.

ENVIRONMENTAL:

1. STORAGE : -40° C TO 85° C.
2. OPERATION : 0° C TO 70° C.



PC Board Layout
Component Side Shown



0769-81585156							
0769-81605156							
单位(units)	MM	设计(draw)	邓辉剑	材料 (mt 1)		图名 (name)	RJ45 JACK 90° 屏蔽带灯
比例(scale)	1 : 1	审核(ch'k)	朱建华	UNIT:mm	.xx +/-0.25, xxx +/-0.13		
版次(rev.)	A / 1	核准(app'd)	朱建华	HOUSING	PBT	料号(Part number)	CLJ5922S-10P8C-1X1
视图(view)		日期(date)	2008.08.12	PIN	Qsn6.5-0.1	图档(File Name)	E:\工程图